

Please add the following claims:

--35. A preform according to claim 5, wherein the unsaturated polyester resin is synthesized from an anhydride wherein the anhydride is tetrachlorophthalic anhydride, tetrabromophthalic anhydride, or hexachloro-endomethylene tetrahydrophthalic anhydride.

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36. A preform according to claim 1, wherein the at least one resin is an unsaturated vinylester resin.

37. A radially deployable flexible preform to form, after deploying, a tubular structure that is curable by polymerization after positioning it in a well or in a line and moulds to the shape thereof after curing, consisting essentially of at least one resin of an unsaturated polyester resin or a vinylester resin comprising in its chemical formula at least one reactive multiple bond that has a dynamic viscosity of less than about 2500 mPa.s at a temperature of about 20°C to about 70°C, and is capable of subsequent reaction with compounds comprising in their constitution at least one terminal reactive multiple bond or a reactive multiple bond positioned at one end or the other of the molecular chain and/or on a pendant group, wherein the preform contains at least one resin with a residual latent period, after storage at 22°C for a period of 20 days or more, of at least 3 hours at a temperature of about 10°C to about 90°C.

38. A radially deployable flexible preform to form, after deploying, a tubular structure that is curable by polymerization after positioning it in a well or in a line and moulds to the shape thereof after curing, consisting of at least one resin of an unsaturated polyester resin or a vinylester resin comprising in its chemical formula at least one reactive multiple bond that has a dynamic viscosity of less than about 2500 mPa.s at a temperature of about 20°C to about 70°C, and is capable of subsequent reaction with at least one polymerisable oligomer and/or at least one monomer of a vinyl, an acrylic, a methacrylic, an allyl or a maleic compound comprising at least one terminal reactive multiple bond or a reactive multiple bond positioned at one end or the other of the molecular chain and/or on a pendant group, wherein the preform contains at least one resin with a residual latent period, after storage at 22°C for a period of 20 days or more, of at least 3 hours at a

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temperature of about 10°C to about 90°C.—